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April 2016



FDD4685\_F085

# P-Channel PowerTrench® MOSFET

-40 V, -32 A, 35 mΩ

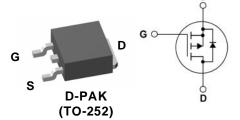
#### **Features**

- Typical  $R_{DS(on)}$  = 23 m $\Omega$  at  $V_{GS}$  = -10V,  $I_D$  = -8.4 A
- Typical  $R_{DS(on)}$  = 30 m $\Omega$  at  $V_{GS}$  = -4.5V,  $I_D$  = -7 A
- Typical  $Q_{g(tot)}$  = 19 nC at  $V_{GS}$  = -5V,  $I_D$  = -8.4 A
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

### **Applications**

- Inverter
- Power Supplies





For current package drawing, please refer to the Fairchild website at http://www.fairchildsemi.com/package-drawings/TO/

#### **MOSFET Maximum Ratings** T<sub>J</sub> = 25°C unless otherwise noted.

Symbol	Parameter	Ratings	Units	
$V_{DSS}$	Drain-to-Source Voltage	-40	V	
$V_{GS}$	Gate-to-Source Voltage	±20	V	
	Drain Current - Continuous (T <sub>C</sub> < 90°C, V <sub>GS</sub> =10) (Note 1)	-32	Α	
ID	Pulsed Drain Current	See Figure 4	7	
E <sub>AS</sub>	Single Pulse Avalanche Energy (Note 2)	121	mJ	
D	Power Dissipation	83	W	
$P_{D}$	Derate Above 25°C	0.56	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature	-55 to + 175	°C	
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.8	°C/W	
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient (Note 3)	40	°C/W	

### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD4685	FDD4685_F085	D-PAK(TO-252)	13"	12mm	2500units

#### Notes:

- 1. Current is limited by bondwire configuration.
- 2. Starting  $T_J = 25^{\circ}C$ , L = 3mH,  $I_{AS} = 9A$ ,  $V_{DD} = 40V$  during inductor charging and  $V_{DD} = 0V$  during time in avalanche. 3.  $R_{\theta,JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{0JC}$  is guaranteed by design, while  $R_{0JA}$  is determined by the board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2oz copper.
- 4. A suffix as "...F085P" has been temporarily introduced in order to manage a double source strategy as Fairchild has officially announced in Aug 2014.

Max.

Min.

Тур.

Units

**Parameter** 

Off Characteristics								
B <sub>VDSS</sub>	Drain-to-Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$	-40	-	-	V		
$\frac{\Delta B_{VDSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	ID = -250μA, referenced to 25°C	-	-33	-	mV/°C		
I <sub>DSS</sub>	Drain-to-Source Leakage Current	V <sub>DS</sub> = -32V	-	-	-1	μА		
$I_{GSS}$	Gate-to-Source Leakage Current	$V_{GS} = \pm 20V$	-	-	±100	nA		

**Test Conditions** 

### **On Characteristics**

Symbol

V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \mu A$	-1	-1.6	-3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	ID = -250μA, referenced to 25°C	-	4.9	-	mV/°C
		I <sub>D</sub> = -8.4A, V <sub>GS</sub> = -10V	-	23	27	
R <sub>DS(on)</sub>	Drain to Source On Resistance	I <sub>D</sub> = -7A, V <sub>GS</sub> = -4.5V	-	30	35	mΩ
		$I_D = -8.4A, V_{GS} = -10V, T_J = 150^{\circ}C$	-	38	45	
g <sub>FS</sub>	Forward Transconductance	ID = -8.4A, VDS = -5V	-	23	-	s

### **Dynamic Characteristics**

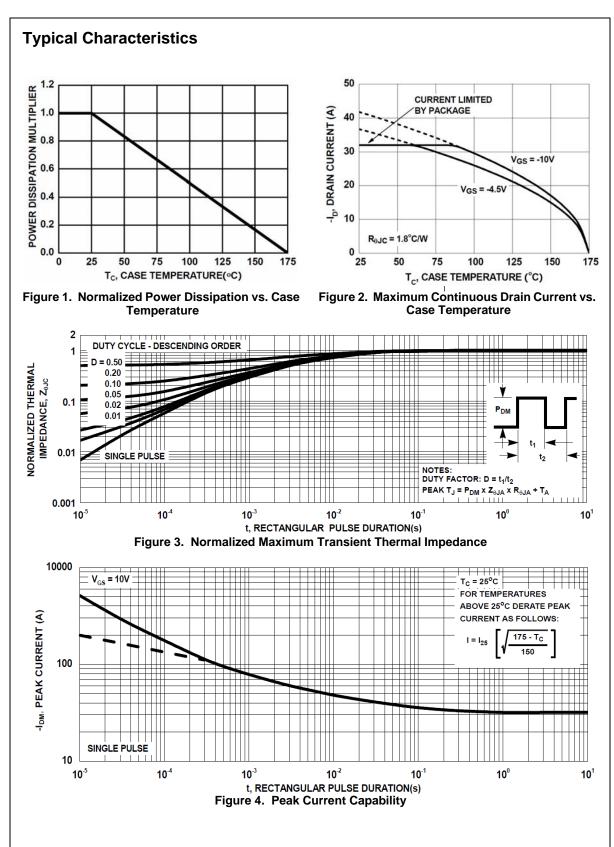
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = -20V, V <sub>GS</sub> = 0V, f = 1MHz	-	1790	2380	pF
Coss	Output Capacitance		-	260	345	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 111112	-	140	205	pF
$R_g$	Gate Resistance	f = 1MHz	-	4	-	Ω
$Q_{g(ToT)}$	Total Gate Charge	V - 20V V - 5V	-	19	27	nC
Q <sub>gs</sub>	Gate-to-Source Gate Charge	$V_{DD} = -20V, V_{GS} = -5V,$ $V_{DD} = -8.4A$	-	5.6	-	nC
$Q_{gd}$	Gate-to-Drain "Miller" Charge	100:474	-	6.1	-	nC

### **Switching Characteristics**

t <sub>d(on)</sub>	Turn-On Delay		-	8	16	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = -20V, I <sub>D</sub> = -8.4A,	-	15	27	ns
t <sub>d(off)</sub>	Turn-Off Delay	$V_{GS}$ = -10V, $R_{GEN}$ = $6\Omega$	-	34	55	ns
t <sub>f</sub>	Fall Time		1	14	26	ns

### **Drain-Source Diode Characteristics**

$V_{SD}$	Source-to-Drain Diode Voltage	$I_{SD} = -8.4A, V_{GS} = 0V$	-	-0.85	-1.2	V
t <sub>rr</sub>	Reverse-Recovery Time	I = 9.40 dl /dt = 1000/	-	30	45	ns
$Q_{rr}$	Reverse-Recovery Charge	$I_{SD} = -8.4A$ , $dI_{SD}/dt = 100A/\mu s$	-	31	47	nC



## **Typical Characteristics**

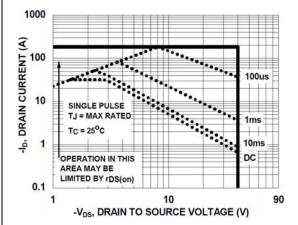
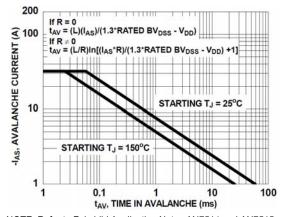


Figure 5. Forward Bias Safe Operating Area



NOTE: Refer to Fairchild Application Notes AN7514 and AN7515

Figure 6. Unclamped Inductive Switching

Capability

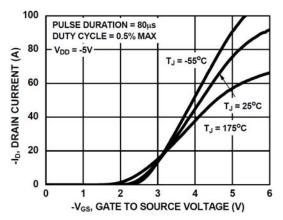


Figure 7. Transfer Characteristics

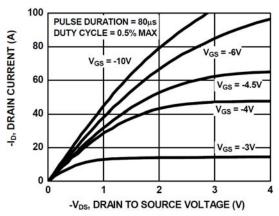


Figure 8. Saturation Characteristics

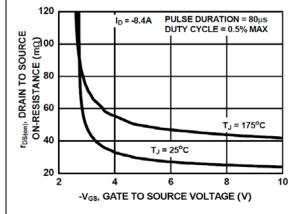


Figure 9. Drain to Source On-Resistance Variation vs. Gate to Source Voltage

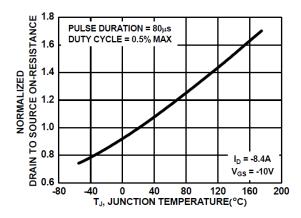


Figure 10. Normalized Drain to Source On Resistance vs. Junction Temperature

## **Typical Characteristics**

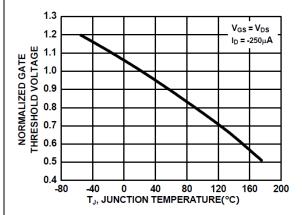


Figure 11. Normalized Gate Threshold Voltage vs.
Junction Temperature

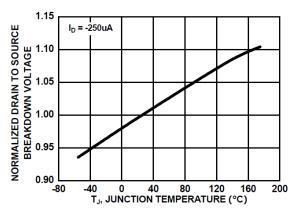


Figure 12. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

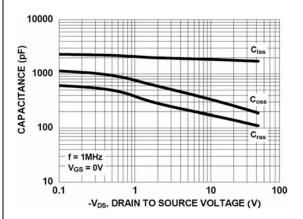


Figure 13. Capacitance vs. Drain to Source Voltage

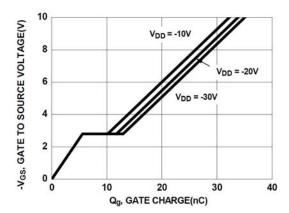


Figure 14. Gate charge vs. Gate to Source Voltage



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